

### **PHOTOTRANSISTOR**

Part Number: AM2520P3C03

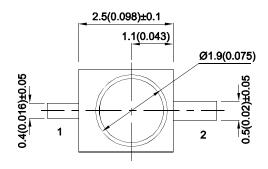
### **Features**

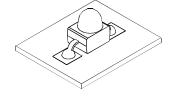
- Subminiature package.
- Gull wing lead.
- Mechanically and spectrally matched to the infrared emitting LED lamp.
- Package: 1000pcs / reel.
- Moisture sensitivity level : level 3.
- RoHS compliant.

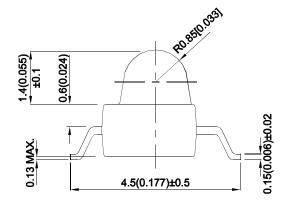
### Description

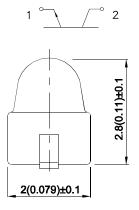
Made with NPN silicon phototransistor chips.

### **Package Dimensions**









DRAWN: L.T.Zhang

APPROVED: Wynec

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.
- Lead spacing is measured where the leads emerge from the package.
   The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.
   The device has a single mounting surface. The device must be mounted according to the specifications.

**CHECKED: Allen Liu** 

SPEC NO: DSAE0824 **REV NO: V.6** DATE: OCT/07/2016





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### Electrical / Optical Characteristics at TA=25°C

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
VBR CEO	Collector-to-Emitter Breakdown Voltage	30			V	Ic=100uA Ee=0mW/cm <sup>2</sup>
VBR ECO	Emitter-to-Collector Breakdown Voltage	5			V	IE=100uA Ee=0mW/cm <sup>2</sup>
VCE (SAT)	Collector-to-Emitter Saturation Voltage			0.8	V	Ic=2mA Ee=20mW/cm <sup>2</sup>
I CEO	Collector Dark Current			100	nA	VcE=10V Ee=0mW/cm <sup>2</sup>
TR	Rise Time (10% to 90%)		15		us	VcE = 5V Ic=1mA RL=1000Ω
TF	Fall Time (90% to 10%)		15		us	
I (ON)	On State Collector Current	0.8	1.5		mA	$VCE = 5V$ $Ee=1mW/cm^2$ $\lambda=940nm$
λ0.1	Range of spectral bandwidth	420		1120	nm	
λр	Wavelength of peak sensitivity		940		nm	
201/2	Angle of half sensitivity		20		deg	

### Absolute Maximum Ratings at TA=25°C

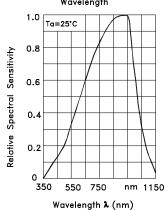
Parameter	Max.Ratings		
Collector-to-Emitter Voltage	30V		
Emitter-to-Collector Voltage	5V		
Power Dissipation at (or below) 25°C Free Air Temperature	100mW		
Operating Temperature	-40°C To +85°C		
Storage Temperature	-40°C To +85°C		

#### Note

Typical Electro-Optical Characteristics Curves

Fig.1 Collector Power Dissipation vs.

Fig.2 Spectral Sensitivity vs.
Wavelength

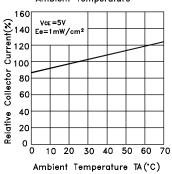


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Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity — Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

Fig.3 Relative Collector Current vs. Ambient Temperature



Collector Current

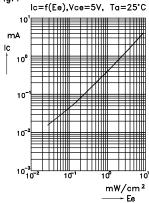


Fig.5 Collector Dark Current vs. Ambient Temperature

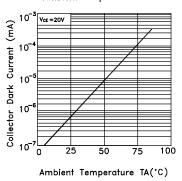


Fig.6 Collector Current vs.

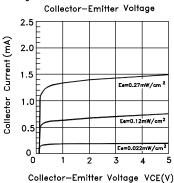
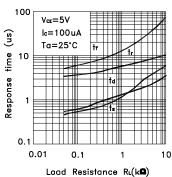
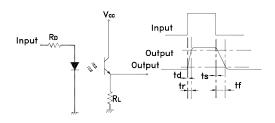


Fig.7 Response Time vs. Load Resistance



Test Circuit for Response Time



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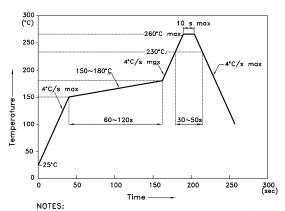
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### AM2520P3C03

Reflow soldering is recommended and the soldering profile is shown below. Other soldering methods are not recommended as they might cause damage to the product.

Reflow Soldering Profile For Lead-free SMT Process.



- NOTES:

  1.We recommend the reflow temperature 245°C(+/-5°C). The maximum soldering temperature should be limited to 260°C.

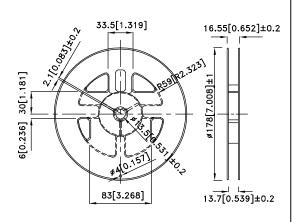
  2.Don't cause stress to the epoxy resin while it is exposed to high temperature.
- 3. Number of reflow process shall be 2 times or less.

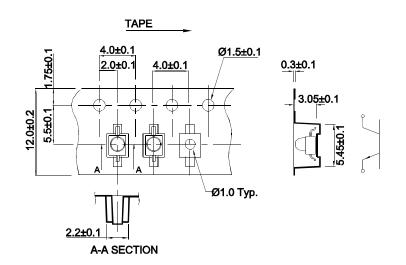
Recommended Soldering Pattern (Units: mm; Tolerance: ± 0.1)



### Tape Specifications (Units : mm)

### **Reel Dimension**

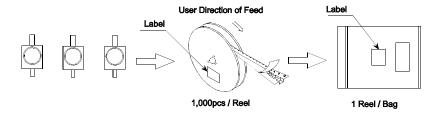


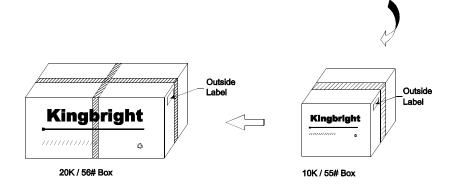


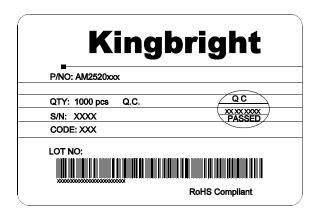
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#### **PACKING & LABEL SPECIFICATIONS**

#### AM2520P3C03







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